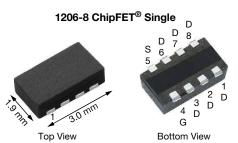


## www.vishay.com

# P-Channel 12 V (D-S) MOSFET



### Marking code: BR

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-12				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.032				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.040				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.8 V	0.052				
Q <sub>g</sub> typ. (nC)	20				
I <sub>D</sub> (A) <sup>a</sup>	-6				
Configuration	Single				

#### **FEATURES**

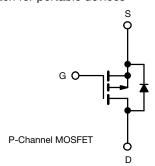
- TrenchFET® power MOSFET
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

Load switch for portable devices



ORDERING INFORMATION	
Package	1206-8 ChipFET
Lead (Pb)-free and halogen-free	Si5475DDC-T1-GE3

ABSOLUTE MAXIMUM RATINGS (	T <sub>A</sub> = 25 °C, unless	otherwise note	ed)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-12	v	
Gate-source voltage		$V_{GS}$	± 8		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-6 <sup>a</sup>		
	T <sub>C</sub> = 70 °C	l , [	-6 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-6 a, b, c		
	T <sub>A</sub> = 70 °C		-5.6 <sup>b, c</sup>	А	
Pulsed drain current		I <sub>DM</sub>	-20		
Continuous common durin dia da commont	T <sub>C</sub> = 25 °C		-4.8		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-1.9 <sup>b, c</sup>		
Maximum power dissipation	T <sub>C</sub> = 25 °C		5.7		
	T <sub>C</sub> = 70 °C		3	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.3 b, c	VV	
	T <sub>A</sub> = 70 °C	]	1.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 5 s	R <sub>thJA</sub>	45	55	°C/W	
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	18	22		

### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The 1206-8 ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 95 °C/W

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# Vishay Siliconix

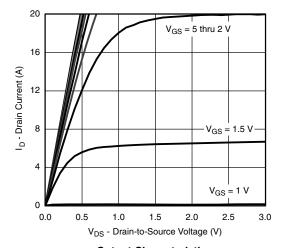
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	1					l	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-12	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-25	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	3	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-	-1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -12 V, V <sub>GS</sub> = 0 V	-	-	-1	μА	
		V <sub>DS</sub> = -12 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C	-	-	-5		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20	-	-	Α	
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -5.4 A	-	0.026	0.032	†	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -4.8 \text{ A}$	-	0.032	0.040	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -2 \text{ A}$	-	0.041	0.052		
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = -6 \text{ V}, I_D = -5.4 \text{ A}$	-	21	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	1600	-		
Output capacitance	Coss	$V_{DS} = -6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	400	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	320	-		
Talal calculation		$V_{DS} = -6 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -7.5 \text{ A}$	-	32	50	nC	
Total gate charge	Qg		-	20	30		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7.5 \text{ A}$	-	2.5	-		
Gate-drain charge	$Q_{gd}$		-	5.5	-		
Gate resistance	Rg	f = 1 MHz	-	4.1	-	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	20	30		
Rise time	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, R_{I} = 1.1 \Omega$	-	40	60		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -5.6 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	45	70		
Fall time	t <sub>f</sub>		-	20	30		
Turn-on delay time	t <sub>d(on)</sub>		-	10	15	ns	
Rise time	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, R_{L} = -1.1 \Omega$	-	12	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -5.6 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$	-	45	70		
Fall time	t <sub>f</sub>	<u> </u>		15	25		
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-4.8	_	
Pulse diode forward current	I <sub>SM</sub>		-	-	-20	A	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = -5.6 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	42	65	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	F C A di/d+ 100 A / T 05 00	-	50	75	nC	
Reverse recovery fall time	ta	$I_F = -5.6 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 °\text{C}$	-	20	-		
Reverse recovery rise time	t <sub>b</sub>	1	_	22	_	ns	

#### Notes

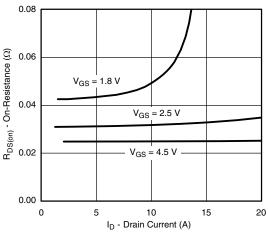
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

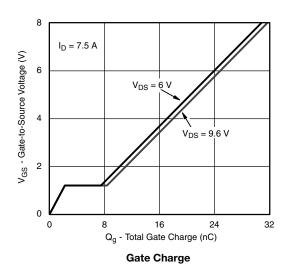


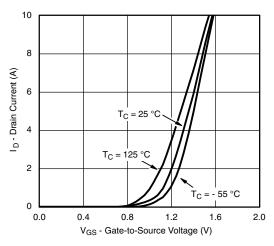


### **Output Characteristics**

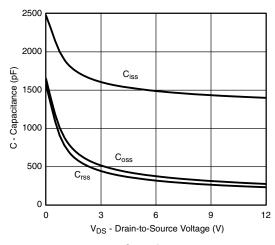


On Resistance vs. Drain Current

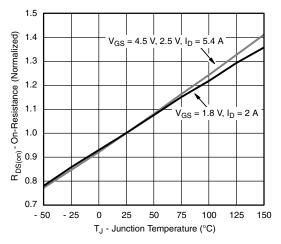




**Transfer Characteristics** 

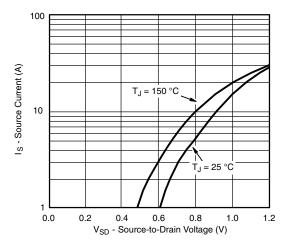


Capacitance

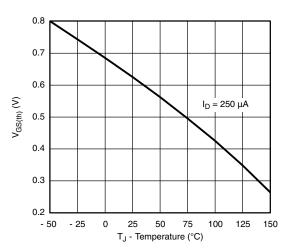


On-Resistance vs. Junction Temperature

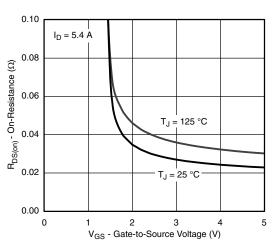




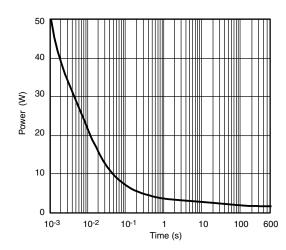
Forward Diode Voltage vs. Temperature



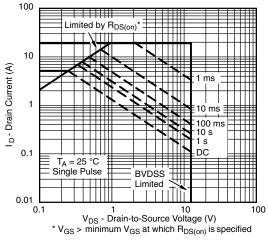
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

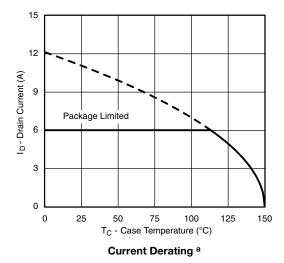


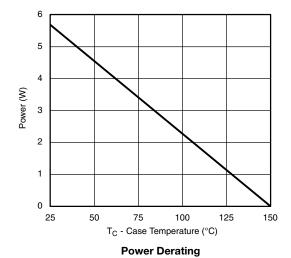
Single Pulse Power



Safe Operating Area, Junction-to-Ambient



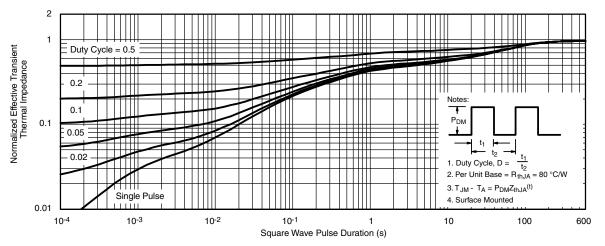




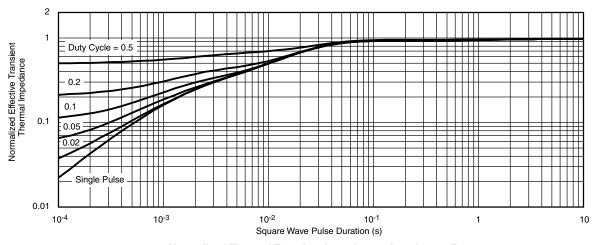
### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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